

Theme : Engineering the Building Blocks of a Smart City

Date : 9 April, 2019 (Tue) Time : 9:00 am - 5:30 pm

Venue : Charles K Kao Auditorium, Hong Kong Science Park

Programme Highlights

The Electronics Division of the Hong Kong Institution of Engineers is going to hold the flagship programme "Hong Kong Electronics Symposium 2019 (HKES2019)" with the theme "Engineering the Building Blocks of a Smart City". The topics of interest cover 5G, Smart Lamp Post, V2X, Smart Grid and Deep Learning, etc. As well as technology aspects, market trends and policies to drive Smart Cities will also be discussed. With HKES2019 covering various emerging disruptive technologies, it is the Symposium that should not to be missed.

Fee

\$700 (For Members of HKIE and HKES supporting organisation) \$900 (For non-Members)

Early Bird Registration on or before 18-March-2019

\$350 For Members of HKIE and HKES 2019 supporting organisations

\$450 For non-Members

Organiser:



Registration and Enquiry

For registration, please kindly complete the on-line registration form via EN Division website http://en.hkie.org.hk or the QR code on the right hand side with full payment. Successful applicants will be notified before the event.

For enquiries, please contact Ms Veronica Cheng at (852) 2734 3312 OR at email veronica@pctourshk.com



On-line Registration

Rundown









Smart People

	Smart Economy
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Time	Activity	Speaker / Moderator	
08:30 -	Registration		
09:00			
	Welcome Speech	Ir John Chan	
		Chairman, HKES2019 Organisation Committee Deputy Chairman, HKIE Electronics Division	
	On a via a Constant		
	Opening Speech	Ir Ringo Yu HKIE President	
	Keynote Speech	Mr. Victor Lam, JP	
	A mark a source of the second	Government Chief Information Officer	
	Smart City Blueprint	Office of the Government Chief Information	
	Smart city blueprint	Officer	
	Awards presentation to Hong Kong		
	Electronics Project Competition 2019		
	winners & souvenir presentation		
	Rring the World into 5G Era	Mr. Philip Yick	
		Wireless Solution Director, Huawei	
	Shaping Connected Mobility	Mr. Daniel Weitze	
		Head of Digital Mobility, Siemens	
	Tea Break		
	Smart Grid Realization -	Ir Bowie Bui	
	Advanced Metering Infrastructure	Senior Project Manager – AMI, CLP Power	
	(AMI) Implementation	Hong Kong Limited	
	Panel Discussion (Morning)	Facilitator	
		Mr. Simon Wong	
	Mhat does it take to Engineer the	CEO, Logistics and Supply Chain MultiTech	
	Building Blocks of a Smart City?	R&D Centre	
		Panelists	
		Ir Dr the Hon Wai-kwok Lo, SBS, MH, JP Legislative Councilor	
		Hon Charles Peter Mok, JP	
		Legislative Councilor	
		Mr. Daniel Weitze Head of Digital Mobility, Siemens	
		Mr. Gary Yeung	
		Vice President, Smart City Consortium	
12:15 –	Lunch		
13:45			
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Time	Activity	Speaker / Moderator
	Keynote Speech Smart Economy	Dr. MeiKei leong Chief Technology Officer, ASTRI
	Smart Mobility	Dr. Henry Wong Head of Strategic Wireless Technology & Core Networks – Engineering, HKT
	Smart Living: Security Risks & RF Coexistence Issues of Smart Devices	Mr. Nick Pugh Marketing Segment Manager, Wireless Communication, Device Test, Rohde & Schwarz
	Panel Discussion (Afternoon) 5G – Creating New Era of Innovation and Experience	Facilitator Mr. William Tse Head of Strategic Engagement Hong Kong, Taiwan, Macau, GSMA
	innovation and experience	Panelists Mr. Andy Bien Chief Information Officer, Airport Authority Mr. Alex Cheng Principal Engineer, China Mobile Hong Kong
		Mr. Xuezheng Peng Principal Researcher, Tencent Ltd. Dr. Henry Wong
		Head of Strategic Wireless Technology & Core Networks – Engineering, HKT Mr. Philip Yick Wireless Solution Director, Huawei
	Tea Break	
	When IP meets AI: Bring Virtual Characters into your Smart Digital Life	Mr. Xuezheng Peng Principal Researcher, Tencent Ltd.
	Deep Learning Technology and Its Recent Developments	Prof Francis Chin Emeritus and Honorary Professor, University of Hong Kong Dr. Bethany Chan Honorary Associate Professor, University of Hong Kong
	Closing Speech	Ir Wilson Kwok Chairman, HKIE Electronics Division
17:30	End of Hong Kong Electronics Symposium 2019	

Steering Committee

Ir Wilson WS Kwok

Chairman, Electronics Division The Hong Kong Institution of Engineers

Ir Victor Ng

Honorary Chairman and Immediate Past Chairman, Hong Kong Electronics & Technologies Association

Mr. Simon Wong

Chief Executive Officer Logistics and Supply Chain MultiTech R&D Centre Limited

Ir Peter TC Yeung

Head of Electronics & ICT Clusters, Smart City Platform Hong Kong Ścience and Technology Parks Corporation

Ir Ringo SM Yu

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